## 11-13-2000

10.05.00

## 101513127

## RECORDATION FORM COVER SHEET

Docket: 0819-430

To the	ne Honorable Assistant Commissioner for Patent. Please record the attached original documents or copy thereof.	<u>و</u>					
1.	Name of conveying parties: Shinji NAKAMURA, Masahiro ISHIDA, Kenji ORITA, Osamu IMAFUJI, Masaaki YU						
Addit	itional name(s) of conveying party(ies) attached? [] Yes [X] No						
2.	Name and address of receiving party:						
Name	e: Matsushita Electronics Corporation						
	et Address: 1-1, Saiwai-cho, Takatsuki-shi, Osaka 569-1193, Japan	j j					
City_	State ZIP itional name(s) & addresses(es) attached? [ ]Yes [X] No						
Addit	itional name(s) & addresses(es) attached? [ ]Yes [X] No						
3.	Name of Conveyance:						
-/-	[X] Assignment [] Merger						
	Security Agreement [] Change of Name						
	[ ] Other						
	Execution Date: October 3, 2000						
4.	Application number(s) or patent number(s):	00					
	If this document is being filed together with a new application, the execution date of the application is: October 3, 20	<u>J0</u>					
	Title: SEMICONDUCTOR DEVICE, SEMICONDUCTOR SUBSTRATE, AND MANUFACTURE METHOD  A: Patent Application No.(s)  B. Patent No.(s)						
	A: Patent Application No.(s)  Additional numbers attached? Yes No						
	Additional numbers attached: res res						
5.	Name and address of party to whom correspondence concerning document should be mailed:						
J.	Name: NIXON PEABODY LLP						
	Street Address: \$180 Greenshoro Drive, Suite 800						
	City: McLean State: Virginia ZIP 22102						
6.	Total number of applications and patents involved: 1 09/680054						
7.	Total fee (37 CFR 3.41):\$40.00						
	X Enclosed Authorized to be changed to deposit account						
8.	Deposit Account Number:(Attach duplicate copy of this page if paying by deposit account)						
σ.	(Attach duplicate copy of this page it paying by deposition						
	DO NOT USE THIS SPACE						
9.	Statement and signature.	py of the original					
	Statement and signature.  To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true co						
docu	cument. 10/5-100						
	Date						
Eric	me of Person Signing  Test number of pages including cover sheet, attachments, and document: 3						
Nan	me of Person Signing  Total number of pages including cover sheet, attachments, and document: 3						
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PATENT REEL: 011217 FRAME: 0459

Attorney Dock	et No
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## ASSIGNMENT

	WHE	REAS, Shinji NAKAMURA, Masahiro ISHIDA, Kenji ORITA, Osamu				
certaii	n new	<u>lasaaki YURI</u> (hereinafter designated as the undersigned) has (have) invented and useful improvements in <u>SEMICONDUCTOR DEVICE</u> , <u>UCTOR SUBSTRATE</u> , <u>AND MANUFACTURE METHOD</u>				
for wh	ich the	undersigned has (have):				
	(a)	filed an application for Letters Patent of the United States of America on having Serial No; or				
	(b) executed an application for Letters Patent of the United States of America on t date(s) indicated below; and					
	WHE	REAS, <u>Matsushita Electronics Corporation</u> of				
1-1, S	aiwai-c	ho, Takatsuki-shi, Osaka 569-1193, Japan				
is desi	rous of	essors, legal representatives and assigns (hereinafter designated as the Assignee) acquiring the entire right, title and interest in and to said invention and in and to stent(s) that may be granted therefor in the United States of America;				
	NOW,	THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the				

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents do sell, assign and transfer unto the Assignee the full and exclusive right to the said invention in the United States of America and its territories and for all foreign countries, dependencies and possessions and the entire right, title and interest in and to the application and any and all Letters Patent(s) which may be granted therefor in the United States of America and its territories, dependencies and possessions, and in and to any and all divisions, reissues, continuations and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or any continuation, division or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims under or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

PATENT REEL: 011217 FRAME: 0460 The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein hereby conveyed to the Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States of America resulting from said application or any division or divisions or continuing or reissue applications thereof to the Assignee, as Assignee of the entire interest, and hereby convenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

This Assignment has been executed by the undersigned on the date(s) indicated.

Date:	Oct.	3,	2000	Styl Ta. Camer Ca
				Shinji NAKAMURA
Date:	Oct.	٦,	2000	Masalino Isluda Masahiro ISHIDA
Date:	Oct.	3,	2000 ,	<u>Kenji Orta</u> Kenji ORITA
Date:	Oct.	3,	2000	Osamu IMAFUJI
Date:	Oct.	স,	2000	Masaaki YURI
			,	
24.01				
Date:			,	
Date:				

**RECORDED: 10/05/2000** 

PATENT REEL: 011217 FRAME: 0461

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